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150mA, 75V Surface Mount Switching Diode

FEATURES

- Low power loss, high efficiency
- High surge current capability
- Hermetically sealed glass
- RoHS Compliant

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- On-board DC/DC converter

MECHANICAL DATA

- Case: MMELF
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Polarity: Indicated by cathode band
- Weight: 30.60mg (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I _F	150	mA	
V _{RRM}	75	V	
I _{FSM}	4	А	
V_F at I_F = 100mA	1	V	
T _{J MAX}	175	°C	
Package	MMELF		
Configuration	Single die		









ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)				
PARAMETER		SYMBOL	VALUE	UNIT
Power dissipation		P _D	500	mW
Repetitive peak reverse voltage		V _{RRM}	75	V
Forward current		١ _F	150	mA
Non-repetitive peak forward surge current	t = 1s	I _{FSM}	0.5	A
	t = 1ms		1.0	A
	t = 1µs		4.0	A
Repetitive peak forward current		I _{FRM}	450	mA
Junction temperature range		TJ	-65 to +175	°C
Storage temperature range		T _{STG}	-65 to +175	°C

THERMAL PERFORMANCE				
PARAMETER	SYMBOL	LIMIT	UNIT	
Junction-to-ambient thermal resistance	R _{eja}	300	°C/W	

LL4148/LL4448/LL914B



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ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	MIN	MAX	UNIT
Reverse Breakdown Voltage		Ι _R = 100μΑ	V_{BR}	100	-	V
		Ι _R = 5μΑ		75	-	V
	LL4448 LL914B I _F = 5mA, T _J = 25°C		0.62	0.72	V	
Forward voltage ⁽¹⁾	LL4148	$I_F = 50 \text{mA}, T_J = 25^{\circ}\text{C}$	V _F	-	1	V
	LL4448 LL914B	I _F = 100mA, T _J = 25°C		-	1	V
Reverse current @ rated V _R ⁽²⁾		$V_{R} = 20V, T_{J} = 25^{\circ}C$	I _R	-	25	nA
		$V_{R} = 75V, T_{J} = 25^{\circ}C$		-	5	μA
Junction capacitance		1 MHz, V _R =0V	CJ	-	4	рF
Reverse Recovery Time		$I_F = I_R = 10mA,$ $R_L = 100\Omega, I_{RR} = 1mA$	t _{rr}	-	4	ns

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING	
LL4148 L0	MMELF	10,000 / 13" Tape & Reel	
LL4448 L0	MMELF	10,000 / 13" Tape & Reel	
LL914B L0	MMELF	10,000 / 13" Tape & Reel	
LL4148 L0G	MMELF	10,000 / 13" Tape & Reel	
LL4448 L0G	MMELF	10,000 / 13" Tape & Reel	
LL914B L0G	MMELF	10,000 / 13" Tape & Reel	

Notes:

1. Above ordering codes L0/L0G refer to physically identical parts without any differences



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)





Fig.3 Admissible Power Dissipation Curve









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CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$





PACKAGE OUTLINE DIMENSIONS



4. DWG NO. REF: HQ2SD07-MMELFG-044 REV A.

SUGGESTED PAD LAYOUT



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